

WHAT IS CLAIMED IS:

1. An exposure apparatus having a projection optical system for projecting a pattern formed on a master onto  
5 a substrate, a stage capable of moving with respect to the projection optical system while holding at least either object of the substrate and master, and a lens barrel support which supports the projection optical system, including:
- 10 an interferometer system having an interferometer for measuring a Z position and displacement of the stage with respect to the lens barrel support by using a Z measuring mirror which is arranged on the stage and has a reflecting surface substantially parallel to an  
15 XY plane.
2. The apparatus according to claim 1, wherein said interferometer system includes a plurality of interferometer systems arranged on the apparatus.
3. The apparatus according to claim 1, wherein a  
20 tilt amount of the stage is measured using measurement results of said plurality of interferometer systems.
4. The apparatus according to claim 1, wherein said interferometer system includes a plurality of interferometer systems arranged on the apparatus over  
25 the projection optical system.
5. The apparatus according to claim 1, wherein said interferometers in said interferometer systems have

overlapping measurable regions, and when the stage is positioned in a region where the measurable regions overlap each other, measurement by said interferometer is switched.

5 6. The apparatus according to claim 1, wherein the apparatus further comprises control means for correcting a position and displacement on the basis of measurement results of the position and displacement by said interferometer systems, and measurement values of  
10 said plurality of interferometers are synchronously received and sent to said control means.

17 7. The apparatus according to claim 1, wherein the interferometer is mounted on at least either of the stage and a movable portion which follows the stage,  
15 the stage has an elongated mirror for Z measurement which is longer in a stroke direction of the movable portion which supports the interferometer, and the elongated mirror for Z measurement uses an upper surface of either of X and Y measuring mirrors.  
20 8. The apparatus according to claim 1, wherein said interferometer system causes measurement light emitted by the interferometer to strike the Z measuring mirror via a plurality of mirrors or prisms attached to the lens barrel support serving as a measurement reference.

25 9. The apparatus according to claim 1, wherein measurement light from said interferometer system is substantially perpendicularly incident on the

reflecting surface of the Z measuring mirror.

10. The apparatus according to claim 1, wherein the interferometer emits a total of four beams including two measurement beams and two reference beams, and the  
5 four beams are formed with a cross-shaped positional relationship at a substantially equal interval.

11. The apparatus according to claim 1, wherein a mirror or prism arranged immediately in front of the Z measuring mirror has at least two reflecting surfaces  
10 for reflecting measurement light to the Z measuring mirror and reference light back to an incident optical path.

12. An exposure apparatus comprising:

a Y stage movable in a Y direction;

15 an X stage movable in an X direction with respect to said Y stage;

a Z mirror which is mounted on said X stage or Y stage and has a reflecting surface parallel to an XY plane;

20 a mirror or prism for guiding to said Z mirror a beam emitted to a Z direction by said Y stage; and

an interferometer for detecting a Z position of said X stage or Y stage by using the beam reflected by said Z mirror.

25 13. The apparatus according to claim 12, wherein said interferometer is mounted on said Y stage or X stage.

14. The apparatus according to claim 12, wherein said

interferometer is mounted in the X or Y direction, the apparatus further comprises an optical element having a reflecting surface for reflecting a beam from the X or Y direction to the Z direction, and said interferometer  
5 emits a beam parallel to the X or Y direction toward said optical element.

15. The apparatus according to claim 12, wherein said mirror or prism for guiding the beam to said Z mirror has a first mirror or prism for reflecting to the X or  
10 Y direction a beam emitted to the Z direction by said Y stage or X stage, and a second mirror or prism for reflecting to the Z direction the beam reflected by the first mirror or prism and irradiating said Z mirror with the beam.

15 16. The apparatus according to claim 15, wherein the first mirror or prism and the second mirror or prism are elongated in the X or Y direction.

17. The apparatus according to claim 15, wherein the second mirror or prism has a reflecting surface for  
20 reflecting to the first mirror or prism a reference light component of the beam reflected by the first mirror or prism.

18. The apparatus according to claim 1, wherein a plurality of interferometers in said interferometer  
25 system have overlapping measurable regions when a central position of the stage is controlled to be near an exposure center.

19. A semiconductor device manufacturing method comprising the steps of:

installing a plurality of semiconductor manufacturing apparatuses including an exposure

5 apparatus in a factory; and

manufacturing a semiconductor device by using the plurality of semiconductor manufacturing apparatuses,

wherein the exposure apparatus has a projection optical system for projecting a pattern formed onto a master to a substrate, a stage capable of moving with respect to the projection optical system while holding at least either object of the substrate and master, and a lens barrel support which supports the projection optical system, and

15 the exposure apparatus includes an interferometer system having an interferometer for measuring a Z position and displacement of the stage with respect to the lens barrel support by using a Z measuring mirror which is arranged on the stage and has a reflecting surface substantially parallel to an XY plane.

20 20. The method according to claim 19, further comprising the steps of:

connecting the plurality of semiconductor manufacturing apparatuses to a local area network;

25 connecting the local area network to an external network outside the semiconductor manufacturing factory;

acquiring information about the exposure apparatus from a database on the external network by using the local area network and the external network; and

5           controlling the exposure apparatus on the basis of the acquired information.

21. The method according to claim 20, wherein a database provided by a vendor or user of the exposure apparatus is accessed via the external network, thereby  
10           obtaining maintenance information of the manufacturing apparatus by data communication, or data communication is performed between the semiconductor manufacturing factory and another semiconductor manufacturing factory via the external network, thereby performing production  
15           management.

22. A semiconductor manufacturing factory comprising:  
          a plurality of semiconductor manufacturing apparatuses including an exposure apparatus;  
          a local area network for connecting said  
20           plurality of semiconductor manufacturing apparatuses;  
          and

          a gateway for connecting said local area network to an external network outside the semiconductor manufacturing factory,  
25           wherein information about at least one of said plurality of semiconductor manufacturing apparatuses can be communicated,

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said exposure apparatus has a projection optical system for projecting a pattern formed on a master onto a substrate, a stage capable of moving with respect to the projection optical system while holding at least  
5 either object of the substrate and master, and a lens barrel support which supports the projection optical system, and

said exposure apparatus includes an interferometer system having an interferometer for  
10 measuring a Z position and displacement of the stage with respect to the lens barrel support by using a Z measuring mirror which is arranged on the stage and has a reflecting surface substantially parallel to an XY plane.

15 23. A maintenance method for an exposure apparatus installed in a semiconductor manufacturing factory, comprising the steps of:

preparing a database for accumulating information about maintenance of the exposure apparatus on an  
20 external network outside a factory where the exposure apparatus is installed;

connecting the exposure apparatus to a local area network in the factory; and

maintaining the exposure apparatus on the basis  
25 of information accumulated in the database by using the external network and the local area network,

wherein the exposure apparatus has a projection

optical system for projecting a pattern formed on a master onto a substrate, a stage capable of moving with respect to the projection optical system while holding at least either object of the substrate and master, and  
5 a lens barrel support which supports the projection optical system, and

the exposure apparatus includes an interferometer system having an interferometer for measuring a Z position and displacement of the stage with respect to  
10 the lens barrel support by using a Z measuring mirror which is arranged on the stage and has a reflecting surface substantially parallel to an XY plane.

24. The apparatus according to claim 1, further comprising:

15 an interface for connecting a network;  
a computer for executing network software for communicating maintenance information of the exposure apparatus via the network; and

a display for displaying the maintenance  
20 information of the exposure apparatus that is communicated by the network software executed by said computer.

25. The apparatus according to claim 24, wherein the network software provides on said display a user  
25 interface for accessing a maintenance database which is provided by a vendor or user of the exposure apparatus and connected to the external network outside a factory



where the exposure apparatus is installed, and enables obtaining information from the database via the external network.

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